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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f452-e-pt

TABLE 1-3: PIC18F4X2 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	DIP	PLCC	TQFP			
RC0/T1OSO/T1CKI RC0 T1OSO T1CKI	15	16	32	I/O O I	ST — ST	PORTC is a bi-directional I/O port. Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2 RC1 T1OSI CCP2	16	18	35	I/O I I/O	ST CMOS ST	Digital I/O. Timer1 oscillator input. Capture2 input, Compare2 output, PWM2 output.
RC2/CCP1 RC2 CCP1	17	19	36	I/O I/O	ST ST	Digital I/O. Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL RC3 SCK SCL	18	20	37	I/O I/O I/O	ST ST ST	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C mode.
RC4/SDI/SDA RC4 SDI SDA	23	25	42	I/O I I/O	ST ST ST	Digital I/O. SPI Data In. I ² C Data I/O.
RC5/SDO RC5 SDO	24	26	43	I/O O	ST —	Digital I/O. SPI Data Out.
RC6/TX/CK RC6 TX CK	25	27	44	I/O O I/O	ST — ST	Digital I/O. USART Asynchronous Transmit. USART Synchronous Clock (see related RX/DT).
RC7/RX/DT RC7 RX DT	26	29	1	I/O I I/O	ST ST ST	Digital I/O. USART Asynchronous Receive. USART Synchronous Data (see related TX/CK).

Legend: TTL = TTL compatible input
 ST = Schmitt Trigger input with CMOS levels
 O = Output
 OD = Open Drain (no P diode to VDD)

CMOS = CMOS compatible input or output
 I = Input
 P = Power

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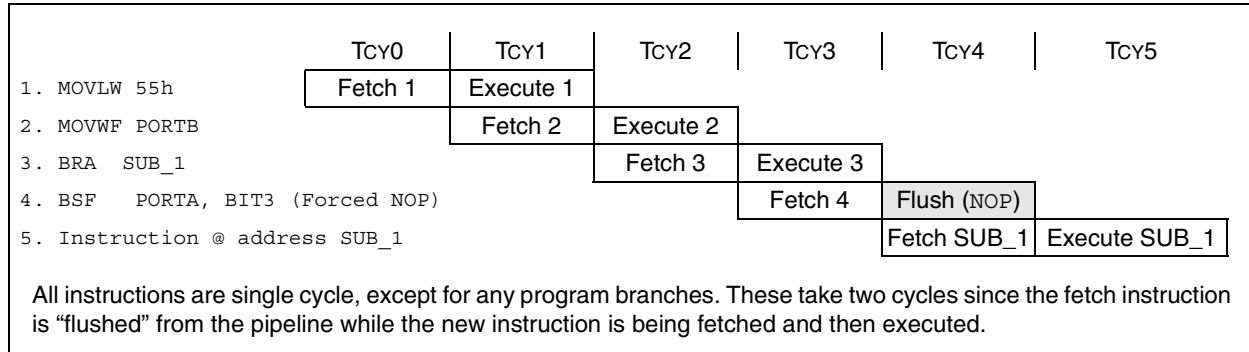
4.6 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO) then two cycles are required to complete the instruction (Example 4-2).

A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register" (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

EXAMPLE 4-2: INSTRUCTION PIPELINE FLOW



4.7 Instructions in Program Memory

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = '0'). Figure 4-5 shows an example of how instruction words are stored in the program memory. To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSB will always read '0' (see Section 4.4).

The CALL and GOTO instructions have an absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1>, which accesses the desired byte address in program memory. Instruction #2 in Figure 4-5 shows how the instruction "GOTO 000006h" is encoded in the program memory. Program branch instructions which encode a relative address offset operate in the same manner. The offset value stored in a branch instruction represents the number of single word instructions that the PC will be offset by. Section 20.0 provides further details of the instruction set.

FIGURE 4-5: INSTRUCTIONS IN PROGRAM MEMORY

			Word Address		
			LSB = 1	LSB = 0	↓
					000000h
					000002h
					000004h
					000006h
Instruction 1:	MOVLW	055h	0Fh	55h	000008h
Instruction 2:	GOTO	000006h	EFh	03h	00000Ah
			F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 456h	C1h	23h	00000Eh
			F4h	56h	000010h
					000012h
					000014h

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NOTES:

8.0 INTERRUPTS

The PIC18FXX2 devices have multiple interrupt sources and an interrupt priority feature that allows each interrupt source to be assigned a high priority level or a low priority level. The high priority interrupt vector is at 000008h and the low priority interrupt vector is at 000018h. High priority interrupt events will override any low priority interrupts that may be in progress.

There are ten registers which are used to control interrupt operation. These registers are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2
- PIE1, PIE2
- IPR1, IPR2

It is recommended that the Microchip header files supplied with MPLAB® IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

Each interrupt source, except INT0, has three bits to control its operation. The functions of these bits are:

- Flag bit to indicate that an interrupt event occurred
- Enable bit that allows program execution to branch to the interrupt vector address when the flag bit is set
- Priority bit to select high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits which enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set. Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared. When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 000008h or 000018h, depending on the priority level. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PICmicro® mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit, which enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit, which enables/disables all interrupt sources. All interrupts branch to address 000008h in Compatibility mode.

When an interrupt is responded to, the Global Interrupt Enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High priority interrupt sources can interrupt a low priority interrupt.

The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (000008h or 000018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The “return from interrupt” instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used), which re-enables interrupts.

For external interrupt events, such as the INT pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set, regardless of the status of their corresponding enable bit or the GIE bit.

Note: Do not use the MOVFF instruction to modify any of the Interrupt control registers while **any** interrupt is enabled. Doing so may cause erratic microcontroller behavior.

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TABLE 9-5: PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output/Timer1 clock input.
RC1/T1OSI/CCP2	bit1	ST	Input/output port pin, Timer1 oscillator input, or Capture2 input/Compare2 output/PWM output when CCP2MX configuration bit is set.
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or Data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or Synchronous Serial Port data output.
RC6/TX/CK	bit6	ST	Input/output port pin, Addressable USART Asynchronous Transmit, or Addressable USART Synchronous Clock.
RC7/RX/DT	bit7	ST	Input/output port pin, Addressable USART Asynchronous Receive, or Addressable USART Synchronous Data.

Legend: ST = Schmitt Trigger input

TABLE 9-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
LATC	LATC Data Output Register								xxxx xxxx	uuuu uuuu
TRISC	PORTC Data Direction Register								1111 1111	1111 1111

Legend: x = unknown, u = unchanged

10.0 TIMER0 MODULE

The Timer0 module has the following features:

- Software selectable as an 8-bit or 16-bit timer/counter
- Readable and writable
- Dedicated 8-bit software programmable prescaler
- Clock source selectable to be external or internal
- Interrupt-on-overflow from FFh to 00h in 8-bit mode and FFFFh to 0000h in 16-bit mode
- Edge select for external clock

Figure 10-1 shows a simplified block diagram of the Timer0 module in 8-bit mode and Figure 10-2 shows a simplified block diagram of the Timer0 module in 16-bit mode.

The T0CON register (Register 10-1) is a readable and writable register that controls all the aspects of Timer0, including the prescale selection.

REGISTER 10-1: T0CON: TIMER0 CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

- bit 7 **TMR0ON:** Timer0 On/Off Control bit
 1 = Enables Timer0
 0 = Stops Timer0
- bit 6 **T08BIT:** Timer0 8-bit/16-bit Control bit
 1 = Timer0 is configured as an 8-bit timer/counter
 0 = Timer0 is configured as a 16-bit timer/counter
- bit 5 **T0CS:** Timer0 Clock Source Select bit
 1 = Transition on T0CKI pin
 0 = Internal instruction cycle clock (CLKO)
- bit 4 **T0SE:** Timer0 Source Edge Select bit
 1 = Increment on high-to-low transition on T0CKI pin
 0 = Increment on low-to-high transition on T0CKI pin
- bit 3 **PSA:** Timer0 Prescaler Assignment bit
 1 = Timer0 prescaler is NOT assigned. Timer0 clock input bypasses prescaler.
 0 = Timer0 prescaler is assigned. Timer0 clock input comes from prescaler output.
- bit 2-0 **T0PS2:T0PS0:** Timer0 Prescaler Select bits
 111 = 1:256 prescale value
 110 = 1:128 prescale value
 101 = 1:64 prescale value
 100 = 1:32 prescale value
 011 = 1:16 prescale value
 010 = 1:8 prescale value
 001 = 1:4 prescale value
 000 = 1:2 prescale value

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

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FIGURE 10-1: TIMER0 BLOCK DIAGRAM IN 8-BIT MODE

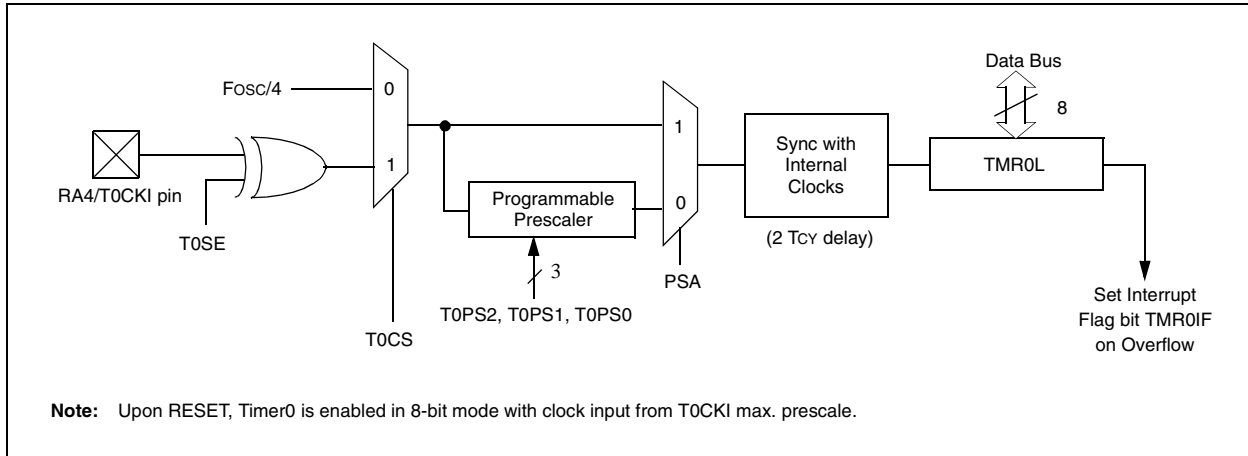
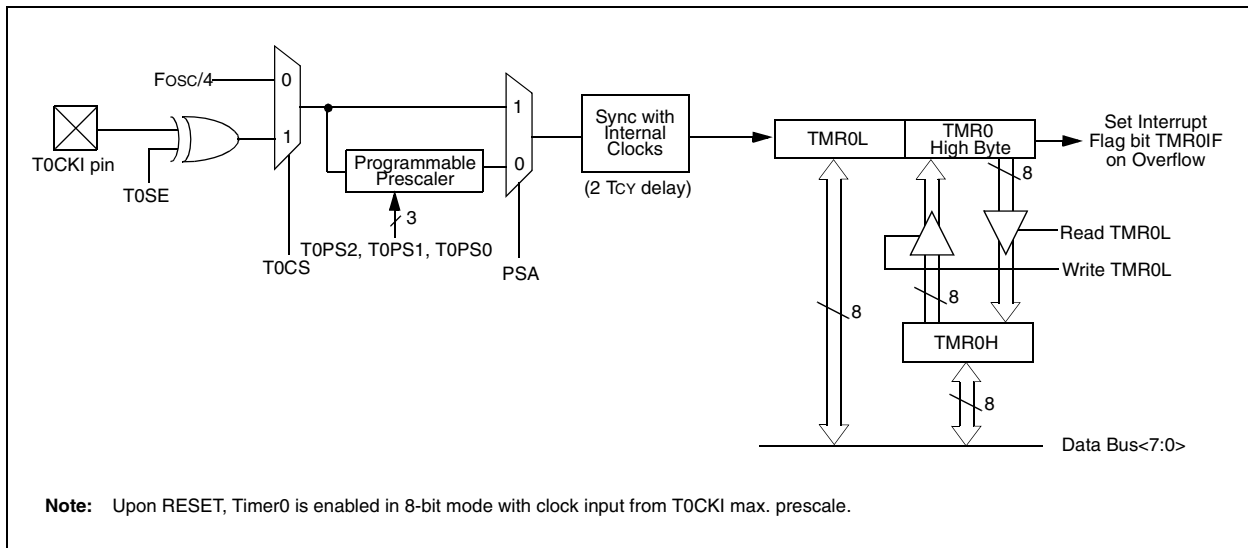


FIGURE 10-2: TIMER0 BLOCK DIAGRAM IN 16-BIT MODE



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NOTES:

14.3 Capture Mode

In Capture mode, CCP1H:CCP1L captures the 16-bit value of the TMR1 or TMR3 registers when an event occurs on pin RC2/CCP1. An event is defined as one of the following:

- every falling edge
- every rising edge
- every 4th rising edge
- every 16th rising edge

The event is selected by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set; it must be cleared in software. If another capture occurs before the value in register CCP1 is read, the old captured value is overwritten by the new captured value.

14.3.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note: If the RC2/CCP1 is configured as an output, a write to the port can cause a capture condition.

14.3.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (either Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer to be used with each CCP module is selected in the T3CON register.

14.3.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit CCP1IE (PIE1<2>) clear to avoid false interrupts and should clear the flag bit, CCP1IF, following any such change in Operating mode.

14.3.4 CCP PRESCALER

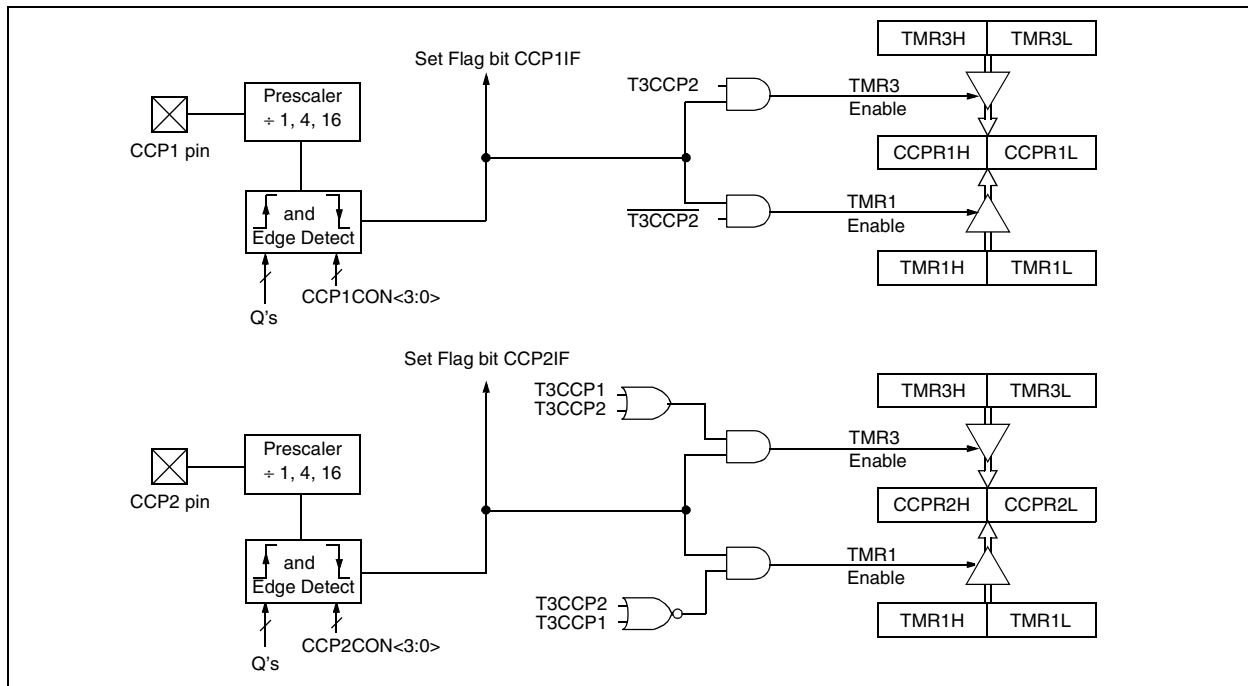
There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any RESET will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore, the first capture may be from a non-zero prescaler. Example 14-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the “false” interrupt.

EXAMPLE 14-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF    CCP1CON, F ; Turn CCP module off
MOVLW  NEW_CAPT_PS ; Load WREG with the
                    ; new prescaler mode
                    ; value and CCP ON
MOVWF   CCP1CON    ; Load CCP1CON with
                    ; this value
```

FIGURE 14-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



15.4.4 CLOCK STRETCHING

Both 7- and 10-bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCL pin to be held low at the end of each data receive sequence.

15.4.4.1 Clock Stretching for 7-bit Slave Receive Mode (SEN = 1)

In 7-bit Slave Receive mode, on the falling edge of the ninth clock at the end of the $\overline{\text{ACK}}$ sequence, if the BF bit is set, the CKP bit in the SSPCON1 register is automatically cleared, forcing the SCL output to be held low. The CKP being cleared to '0' will assert the SCL line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCL line low, the user has time to service the ISR and read the contents of the SSPBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 15-13).

Note 1: If the user reads the contents of the SSPBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.

2: The CKP bit can be set in software, regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence, in order to prevent an overflow condition.

15.4.4.2 Clock Stretching for 10-bit Slave Receive Mode (SEN = 1)

In 10-bit Slave Receive mode, during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address, and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPADD register before the falling edge of the ninth clock occurs, and if the user hasn't cleared the BF bit by reading the SSPBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a data sequence, not an address sequence.

15.4.4.3 Clock Stretching for 7-bit Slave Transmit Mode

7-bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock, if the BF bit is clear. This occurs, regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCL line low, the user has time to service the ISR and load the contents of the SSPBUF before the master device can initiate another transmit sequence (see Figure 15-9).

Note 1: If the user loads the contents of SSPBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.

2: The CKP bit can be set in software, regardless of the state of the BF bit.

15.4.4.4 Clock Stretching for 10-bit Slave Transmit Mode

In 10-bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-bit Slave Receive mode. The first two addresses are followed by a third address sequence, which contains the high order bits of the 10-bit address and the R/W bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode, and clock stretching is controlled by the BF flag, as in 7-bit Slave Transmit mode (see Figure 15-11).

15.4.8 I²C MASTER MODE START CONDITION TIMING

To initiate a START condition, the user sets the START condition enable bit, SEN (SSPCON2<0>). If the SDA and SCL pins are sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and starts its count. If SCL and SDA are both sampled high when the baud rate generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low, while SCL is high, is the START condition and causes the S bit (SSPSTAT<3>) to be set. Following this, the baud rate generator is reloaded with the contents of SSPADD<6:0> and resumes its count. When the baud rate generator times out (TBRG), the SEN bit (SSPCON2<0>) will be automatically cleared by hardware, the baud rate generator is suspended, leaving the SDA line held low and the START condition is complete.

Note: If at the beginning of the START condition, the SDA and SCL pins are already sampled low, or if during the START condition the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLIF is set, the START condition is aborted, and the I²C module is reset into its IDLE state.

15.4.8.1 WCOL Status Flag

If the user writes the SSPBUF when a START sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPCON2 is disabled until the START condition is complete.

FIGURE 15-19: FIRST START BIT TIMING

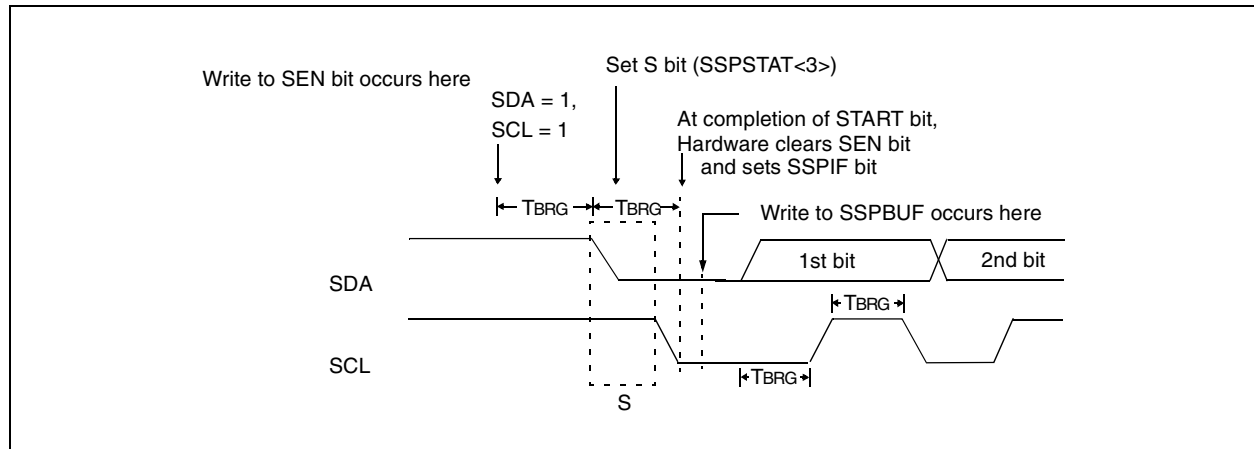


TABLE 16-3: BAUD RATES FOR SYNCHRONOUS MODE

BAUD RATE (Kbps)	Fosc = 40 MHz			33 MHz			25 MHz			20 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
2.4	NA	-	-	NA	-	-	NA	-	-	NA	-	-
9.6	NA	-	-	NA	-	-	NA	-	-	NA	-	-
19.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
76.8	76.92	+0.16	129	77.10	+0.39	106	77.16	+0.47	80	76.92	+0.16	64
96	96.15	+0.16	103	95.93	-0.07	85	96.15	+0.16	64	96.15	+0.16	51
300	303.03	+1.01	32	294.64	-1.79	27	297.62	-0.79	20	294.12	-1.96	16
500	500	0	19	485.30	-2.94	16	480.77	-3.85	12	500	0	9
HIGH	10000	-	0	8250	-	0	6250	-	0	5000	-	0
LOW	39.06	-	255	32.23	-	255	24.41	-	255	19.53	-	255

BAUD RATE (Kbps)	Fosc = 16 MHz			10 MHz			7.15909 MHz			5.0688 MHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
2.4	NA	-	-	NA	-	-	NA	-	-	NA	-	-
9.6	NA	-	-	NA	-	-	9.62	+0.23	185	9.60	0	131
19.2	19.23	+0.16	207	19.23	+0.16	129	19.24	+0.23	92	19.20	0	65
76.8	76.92	+0.16	51	75.76	-1.36	32	77.82	+1.32	22	74.54	-2.94	16
96	95.24	-0.79	41	96.15	+0.16	25	94.20	-1.88	18	97.48	+1.54	12
300	307.70	+2.56	12	312.50	+4.17	7	298.35	-0.57	5	316.80	+5.60	3
500	500	0	7	500	0	4	447.44	-10.51	3	422.40	-15.52	2
HIGH	4000	-	0	2500	-	0	1789.80	-	0	1267.20	-	0
LOW	15.63	-	255	9.77	-	255	6.99	-	255	4.95	-	255

BAUD RATE (Kbps)	Fosc = 4 MHz			3.579545 MHz			1 MHz			32.768 kHz		
	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	0.30	+1.14	26
1.2	NA	-	-	NA	-	-	1.20	+0.16	207	1.17	-2.48	6
2.4	NA	-	-	NA	-	-	2.40	+0.16	103	2.73	+13.78	2
9.6	9.62	+0.16	103	9.62	+0.23	92	9.62	+0.16	25	8.20	-14.67	0
19.2	19.23	+0.16	51	19.04	-0.83	46	19.23	+0.16	12	NA	-	-
76.8	76.92	+0.16	12	74.57	-2.90	11	83.33	+8.51	2	NA	-	-
96	1000	+4.17	9	99.43	+3.57	8	83.33	-13.19	2	NA	-	-
300	333.33	+11.11	2	298.30	-0.57	2	250	-16.67	0	NA	-	-
500	500	0	1	447.44	-10.51	1	NA	-	-	NA	-	-
HIGH	1000	-	0	894.89	-	0	250	-	0	8.20	-	0
LOW	3.91	-	255	3.50	-	255	0.98	-	255	0.03	-	255

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16.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either enable bit SREN (RCSTA<5>), or enable bit CREN (RCSTA<4>). Data is sampled on the RC7/RX/DT pin on the falling edge of the clock. If enable bit SREN is set, only a single word is received. If enable bit CREN is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

1. Initialize the SPBRG register for the appropriate baud rate (Section 16.1).
2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
3. Ensure bits CREN and SREN are clear.
4. If interrupts are desired, set enable bit RCIE.
5. If 9-bit reception is desired, set bit RX9.
6. If a single reception is required, set bit SREN. For continuous reception, set bit CREN.
7. Interrupt flag bit RCIF will be set when reception is complete and an interrupt will be generated if the enable bit RCIE was set.
8. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
9. Read the 8-bit received data by reading the RCREG register.
10. If any error occurred, clear the error by clearing bit CREN.
11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

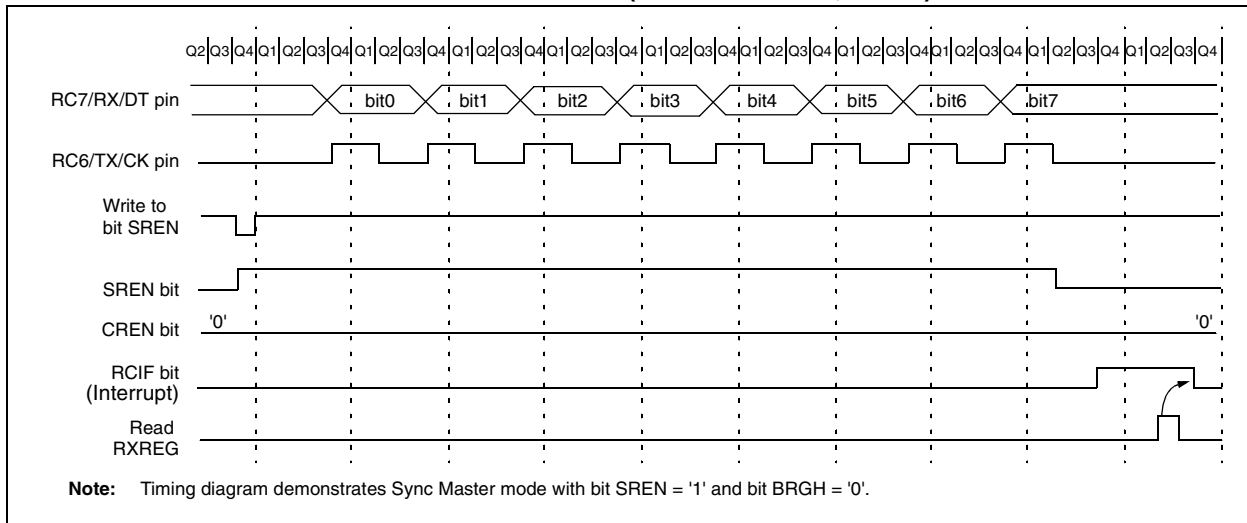
TABLE 16-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
INTCON	GIE/ GIEH	PEIE/ GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	0000 0000	0000 0000
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 -00x	0000 -00x
RCREG	USART Receive Register								0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Master Reception.

Note 1: The PSPIF, PSPIE and PSPIP bits are reserved on the PIC18F2X2 devices; always maintain these bits clear.

FIGURE 16-8: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



PIC18FXX2

18.2 Operation

Depending on the power source for the device voltage, the voltage normally decreases relatively slowly. This means that the LVD module does not need to be constantly operating. To decrease the current requirements, the LVD circuitry only needs to be enabled for short periods, where the voltage is checked. After doing the check, the LVD module may be disabled.

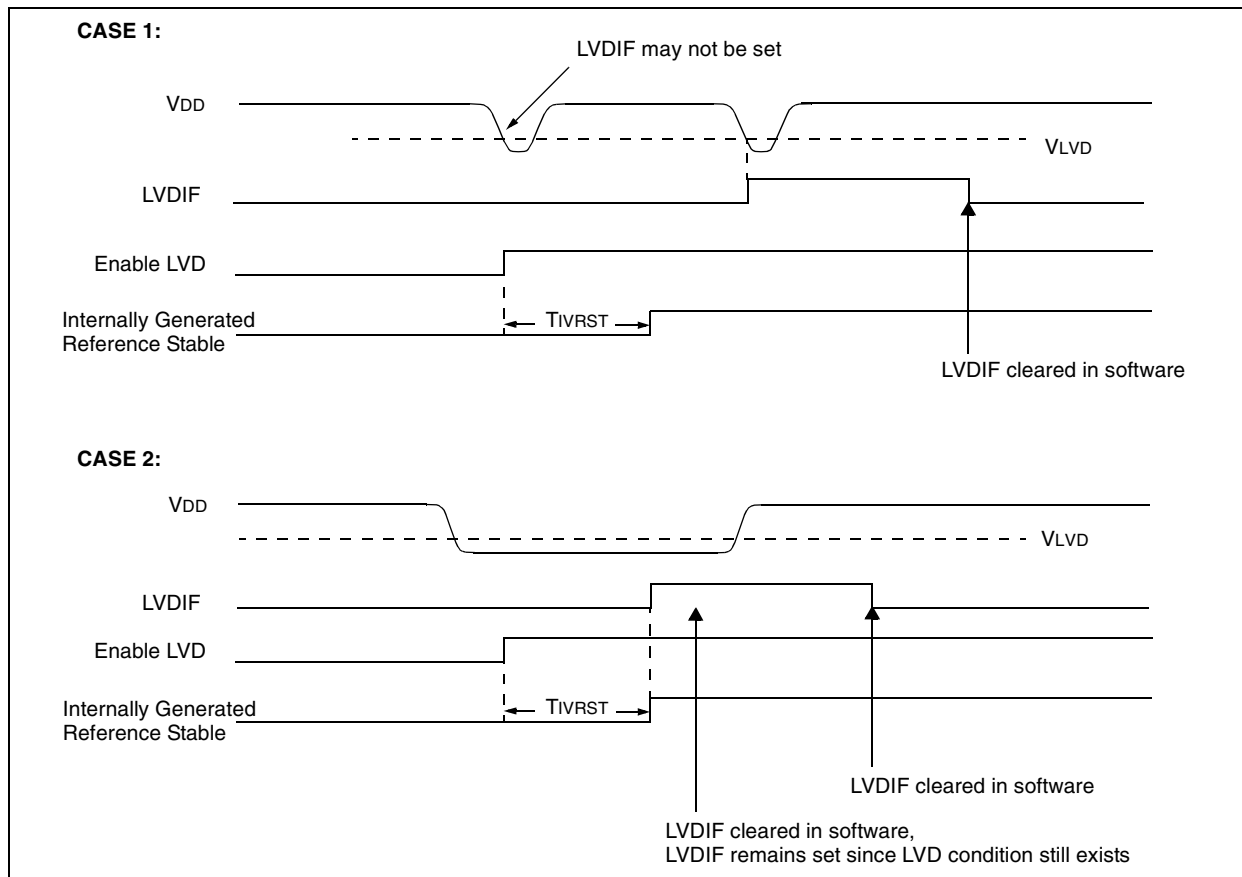
Each time that the LVD module is enabled, the circuitry requires some time to stabilize. After the circuitry has stabilized, all status flags may be cleared. The module will then indicate the proper state of the system.

The following steps are needed to set up the LVD module:

1. Write the value to the LVDL3:LVDL0 bits (LVDCON register), which selects the desired LVD Trip Point.
2. Ensure that LVD interrupts are disabled (the LVDIE bit is cleared or the GIE bit is cleared).
3. Enable the LVD module (set the LVDEN bit in the LVDCON register).
4. Wait for the LVD module to stabilize (the IRVST bit to become set).
5. Clear the LVD interrupt flag, which may have falsely become set until the LVD module has stabilized (clear the LVDIF bit).
6. Enable the LVD interrupt (set the LVDIE and the GIE bits).

Figure 18-4 shows typical waveforms that the LVD module may be used to detect.

FIGURE 18-4: LOW VOLTAGE DETECT WAVEFORMS



19.0 SPECIAL FEATURES OF THE CPU

There are several features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving Operating modes and offer code protection. These are:

- OSC Selection
- RESET
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code Protection
- ID Locations
- In-Circuit Serial Programming

All PIC18FXX2 devices have a Watchdog Timer, which is permanently enabled via the configuration bits or software controlled. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay on power-up only, designed to keep the part in RESET while the power supply stabilizes. With these two timers on-chip, most applications need no external RESET circuitry.

SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. A set of configuration bits are used to select various options.

19.1 Configuration Bits

The configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location 300000h.

The user will note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h - 3FFFFFFh), which can only be accessed using Table Reads and Table Writes.

Programming the configuration registers is done in a manner similar to programming the FLASH memory (see Section 5.5.1). The only difference is the configuration registers are written a byte at a time. The sequence of events for programming configuration registers is:

1. Load table pointer with address of configuration register being written.
2. Write a single byte using the `TBLWT` instruction.
3. Set `EEPGD` to point to program memory, set the `CFGS` bit to access configuration registers, and set `WREN` to enable byte writes.
4. Disable interrupts.
5. Write 55h to `EECON2`.
6. Write AAh to `EECON2`.
7. Set the `WR` bit. This will begin the write cycle.
8. CPU will stall for duration of write (approximately 2 ms using internal timer).
9. Execute a `NOP`.
10. Re-enable interrupts.

NEGf		Negate f					
Syntax:	[<i>label</i>] NEGf f [,a]						
Operands:	$0 \leq f \leq 255$ $a \in [0,1]$						
Operation:	$(\bar{f}) + 1 \rightarrow f$						
Status Affected:	N, OV, C, DC, Z						
Encoding:	<table border="1"><tr><td>0110</td><td>110a</td><td>ffff</td><td>ffff</td></tr></table>			0110	110a	ffff	ffff
0110	110a	ffff	ffff				
Description:	Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value.						
Words:	1						
Cycles:	1						
Q Cycle Activity:							
	Q1	Q2	Q3	Q4			
	Decode	Read register 'f'	Process Data	Write register 'f'			

Example: NEGF REG, 1

Before Instruction

REG = 0011 1010 [0x3A]

After Instruction

REG = 1100 0110 [0xC6]

NOP		No Operation										
Syntax:	[<i>label</i>] NOP											
Operands:	None											
Operation:	No operation											
Status Affected:	None											
Encoding:	<table><tr><td>0000</td><td>0000</td><td>0000</td><td>0000</td></tr><tr><td>1111</td><td>xxxx</td><td>xxxx</td><td>xxxx</td></tr></table>				0000	0000	0000	0000	1111	xxxx	xxxx	xxxx
0000	0000	0000	0000									
1111	xxxx	xxxx	xxxx									
Description:	No operation.											
Words:	1											
Cycles:	1											
Q Cycle Activity:												
	Q1	Q2	Q3	Q4								
	Decode	No operation	No operation	No operation								

Example:

None.

22.2 DC Characteristics: PIC18FXX2 (Industrial, Extended) PIC18LFXX2 (Industrial)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended			
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
D030 D030A D031 D032 D032A D033	V _{IL}	Input Low Voltage I/O ports: with TTL buffer with Schmitt Trigger buffer RC3 and RC4 $\overline{\text{MCLR}}$ OSC1 (in XT, HS and LP modes) and T1OSI OSC1 (in RC and EC mode) ⁽¹⁾	V _{SS} — V _{SS} V _{SS} V _{SS} V _{SS} V _{SS}	0.15 V _{DD} 0.8 0.2 V _{DD} 0.3 V _{DD} 0.2 V _{DD} 0.3 V _{DD} 0.2 V _{DD}	V V V V V V V	V _{DD} < 4.5V 4.5V ≤ V _{DD} ≤ 5.5V
D040 D040A D041 D042 D042A D043	V _{IH}	Input High Voltage I/O ports: with TTL buffer with Schmitt Trigger buffer RC3 and RC4 $\overline{\text{MCLR}}$, OSC1 (EC mode) OSC1 (in XT, HS and LP modes) and T1OSI OSC1 (RC mode) ⁽¹⁾	0.25 V _{DD} + 0.8V 2.0 0.8 V _{DD} 0.7 V _{DD} 0.8 V _{DD} 0.7 V _{DD} 0.9 V _{DD}	V _{DD} V _{DD} V _{DD} V _{DD} V _{DD} V _{DD} V _{DD} V _{DD}	V V V V V V V V	V _{DD} < 4.5V 4.5V ≤ V _{DD} ≤ 5.5V
D060 D061 D063	I _{IL}	Input Leakage Current ^(2,3) I/O ports $\overline{\text{MCLR}}$ OSC1	.02 — —	±1 ±1 ±1	μA μA μA	V _{SS} ≤ V _{PIN} ≤ V _{DD} , Pin at hi-impedance V _{SS} ≤ V _{PIN} ≤ V _{DD} V _{SS} ≤ V _{PIN} ≤ V _{DD}
D070	I _{PU} I _{PURB}	Weak Pull-up Current PORTB weak pull-up current	50	450	μA	V _{DD} = 5V, V _{PIN} = V _{SS}

Note 1: In RC oscillator configuration, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PICmicro device be driven with an external clock while in RC mode.

2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

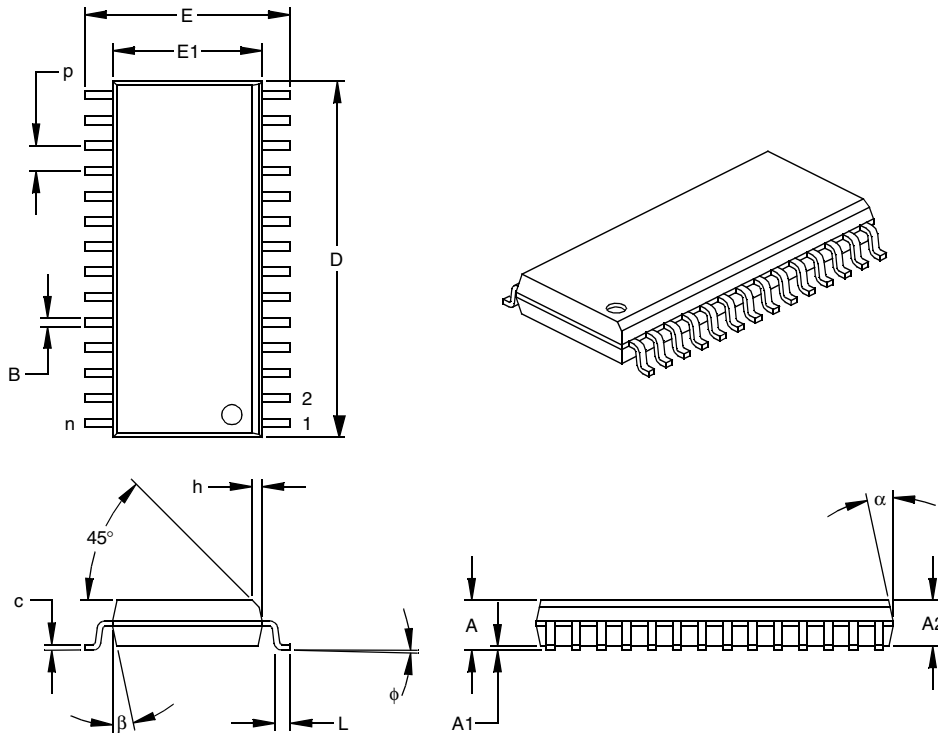
3: Negative current is defined as current sourced by the pin.

4: Parameter is characterized but not tested.

PIC18FXX2

28-Lead Plastic Small Outline (SO) – Wide, 300 mil Body (SOIC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n	28			28		
Pitch	p		.050			1.27	
Overall Height	A	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	E	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.288	.295	.299	7.32	7.49	7.59
Overall Length	D	.695	.704	.712	17.65	17.87	18.08
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle Top	φ	0	4	8	0	4	8
Lead Thickness	c	.009	.011	.013	0.23	0.28	0.33
Lead Width	B	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-013

Drawing No. C04-052

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